



- NOTES:
- MATERIAL:
HOUSING : LCP 30% GLASS FILLED
UL94 V-0,COLOR BLACK
TERMINAL: PHOSPHOR BRONZE 0.12MM REF THICKNESS
 - PLATING FINISHES:
TERMINAL:
CONTACT AREA: 0.8 MICROMETER MIN GOLD
SOLDER TAIL: GOLD FLASH 0.05 MICROMETER MIN.
UNDERPLATING: 2 MICROMETER NICKEL OVERALL
 - PRODUCT SPECIFICATION: PS-47550-001
 - PACKAGING SPECIFICATION: PK-47550-001
 - NO SHARP EDGE INTERFACING WITH THE PCB OR SIM CARD
 - CONTACT MUST NOT EXTENDED HOUSING EDGE DURING DEFLECTION AND MUST LOWER THAN HOUSING LEVEL AFTER 3 TIMES REFLOW
 - PRODUCT COMPLIANT TO ROHS DIRECTIVE 2002/95/EC AND ELV DIRECTIVE 2000/53/EC

RELEASED EC NO: S2015-0672 DRWING:GMENARLY 2014/11/28 CHKD:SICHEONG 2014/12/19 APPR:KHLIM 2014/12/19	QUALITY SYMBOLS $F_A=0$ $F_G=0$ $F_P=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
		4 PLACES ± --- ± ---	3 PLACES ± --- ± ---	2 PLACES ± 0.20 ± ---	1 PLACE ± --- ± ---	0 PLACE ± ±	DRAWN BY GMENARLY	DATE 2014/11/28	TITLE 1.30MM HEIGHT BLOCK SIM CONNECTOR		
		ANGULAR ± 3 °					CHECKED BY SCHEONG	DATE 2014/12/19	molex		
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS					APPROVED BY KHLIM	DATE 2014/12/19	MATERIAL NO. 47550-0001	DOCUMENT NO. SD-47550-002	SHEET NO. 1 OF 1
1	REV	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									